

Electrical Characteristics @ Tj = 25°C (Unless Otherwise Specified)

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions		
BV _{DSS}	Drain-to-Source Breakdown Voltage	100			V	$V_{GS} = 0V, I_{D} = 1.0mA$		
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.10		V/°C	Reference to 25°C, I _D = 1.0mA		
R _{DS(on)}	Static Drain-to-Source On-Resistance			0.18	Ω	V _{GS} = 10V, I _{D2} = 5.0A ④		
				0.195		V _{GS} = 10V, I _{D1} = 8.0A ④		
V _{GS(th)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		
Gfs	Forward Transconductance	3.0			S	V _{DS} = 15V, I _{D2} = 5.0A ④		
I _{DSS}	Zero Gate Voltage Drain Current			25		V_{DS} =80 V, V_{GS} = 0V		
				250	μA	$V_{DS} = 80V, V_{GS} = 0V, T_{J} = 125^{\circ}C$		
I _{GSS}	Gate-to-Source Leakage Forward			100	nA	$V_{GS} = 20V$		
	Gate-to-Source Leakage Reverse			-100	ш	V _{GS} = -20V		
Q_G	Total Gate Charge			28.51		$I_{D1} = 8.0A$		
Q_GS	Gate-to-Source Charge			6.34	nC	V _{DS} = 50V		
Q_GD	Gate-to-Drain ('Miller') Charge			16.59		V _{GS} = 10V		
$t_{d(on)}$	Turn-On Delay Time			30		$V_{DD} = 50V$		
tr	Rise Time			75		$I_{D1} = 8.0A$ $R_G = 7.5\Omega$		
$t_{d(off)}$	Turn-Off Delay Time			40	ns			
t _f	Fall Time			45		V _{GS} = 10V		
Ls +L _D	Total Inductance		7.0			Measured from Drain lead (6mm / 0.25 from package) to Source lead (6mm/ 0.2 in from package) with Source wire internally bonded from Source pin to Drapin		
C _{iss}	Input Capacitance		650			V _{GS} = 0V		
C _{oss}	Output Capacitance		240		pF	V _{DS} = 25V		
C _{rss}	Reverse Transfer Capacitance		44			f = 1.0MHz		

Source-Drain Diode Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Is	Continuous Source Current (Body Diode)			8.0	^	
I _{SM}	Pulsed Source Current (Body Diode) ①			32	A	
V_{SD}	Diode Forward Voltage			1.5	V	$T_J = 25^{\circ}C, I_S = 8.0A, V_{GS} = 0V$
t _{rr}	Reverse Recovery Time			300	ns	$T_J = 25^{\circ}C, I_F = 8.0A, V_{DD} \le 50V$
Q _{rr}	Reverse Recovery Charge			3.0	μC	di/dt = 100A/μs ④
t _{on}	Forward Turn-On Time	Intrins	ic turn-c	n time i	s negligi	ible (turn-on is dominated by L _S +L _D)

Thermal Resistance

Symbol	Parameter	Min.	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case			5.0	°C/\\/
$R_{\theta JA}$	Junction-to-Ambient (Typical Socket Mount)			175	°C/W

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- $^{\circ}$ V_{DD} = 25V, starting T_J = 25°C, Peak I_L = 8.0A.
- $\exists \quad I_{SD} \leq 8.0 A, \ di/dt \leq 140 A/\mu s, \ V_{DD} \leq 100 V, \ T_{J} \leq 150 ^{\circ} C, \ Suggested \ R_{G} = 7.5 \ \Omega$
- 4 Pulse width $\leq 300 \ \mu s$; Duty Cycle $\leq 2\%$

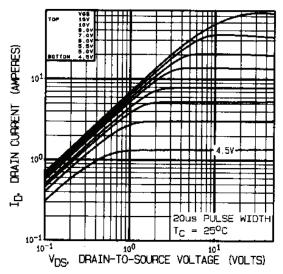


Fig 1. Typical Output Characteristics

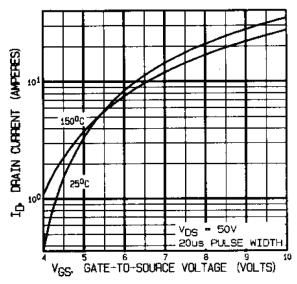


Fig 3. Typical Transfer Characteristics

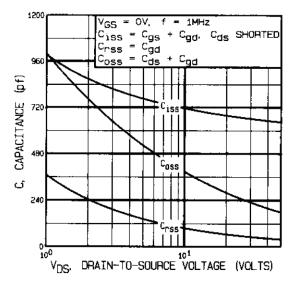


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

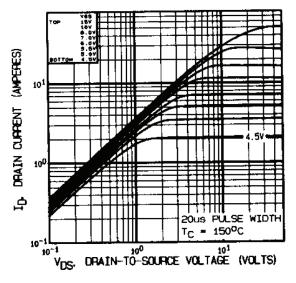


Fig 2. Typical Output Characteristics

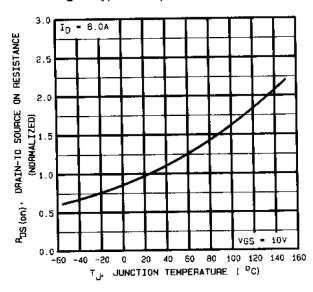


Fig 4. Normalized On-Resistance Vs. Temperature

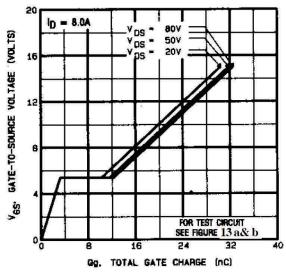


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

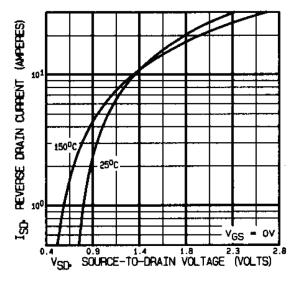


Fig 7. Typical Source-Drain Diode

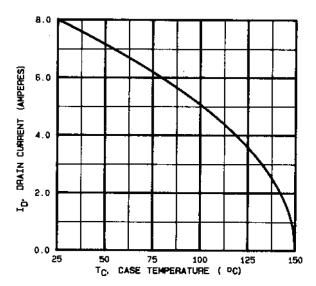


Fig 9. Maximum Drain Current Vs. Case Temperature

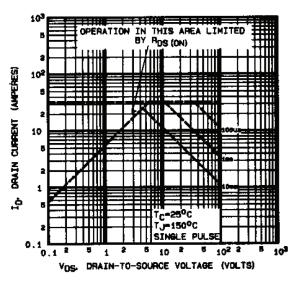


Fig 8. Maximum Safe Operating Area

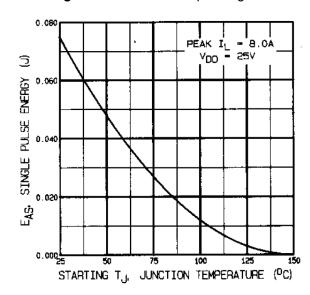


Fig 10. Maximum Avalanche Energy Vs. Drain Current

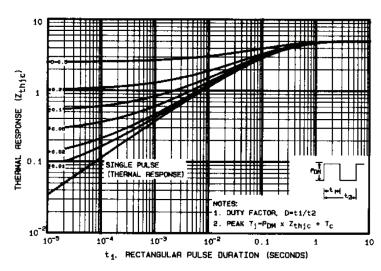


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

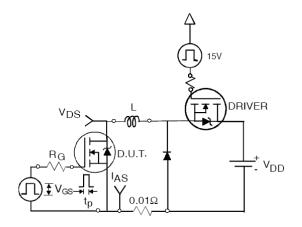


Fig 12a. Unclamped Inductive Test Circuit

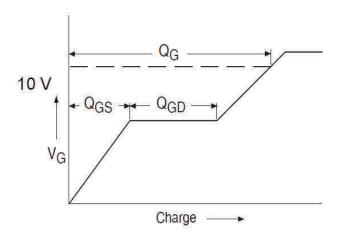


Fig 13a. Gate Charge Waveform

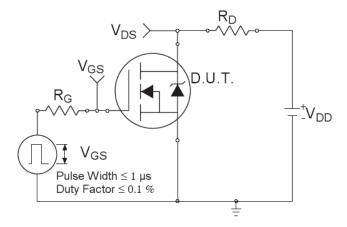


Fig 14a. Switching Time Test Circuit

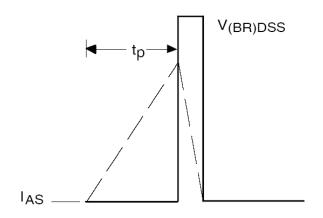


Fig 12b. Unclamped Inductive Waveforms

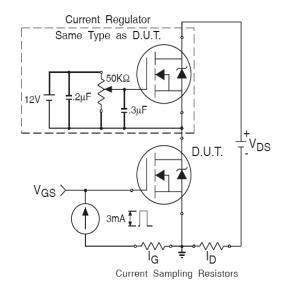


Fig 13b. Gate Charge Test Circuit

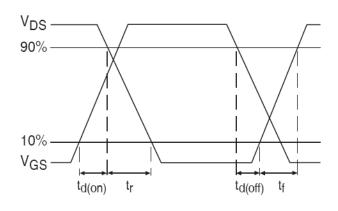
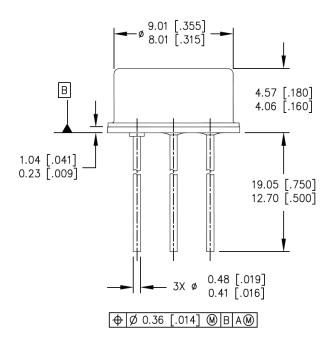


Fig 14b. Switching Time Waveforms



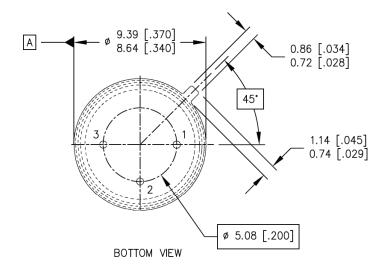
Case Outline and Dimensions - TO-205AF (TO-39)



NOTES: SIDE VIEW

1. DIMENSIONING AND TOLERANCING PER ASME 14.5M-1994.

- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- 3. CONTROLLING DIMENSION: INCH.
- 4. CONFORMS TO JEDEC OUTLINE TO-205AF (TO-39).



LEGEND

- 1- SOURCE
- 2- GATE
- 3- DRAIN (CONNECTED TO THE CASE)



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